

N-channel 100 V, 53 mOhm standard level ASFET with enhanced SOA in DFN2020. Designed for high power PoE, inrush management, eFuse and relay replacement 12 December 2023 Product data sheet

1. General description

New standards and proprietary approaches are enabling Power-over-Ethernet (PoE) systems capable of delivering up to 90 W to each powered device (PD). Such solutions place increased demands on the power sourcing equipment (PSE) in terms of "soft-start", thermal management and power density requirements. These ASFETs combine enhanced SOA in a compact 2 mm x 2 mm footprint making them ideally placed for a variety of applications including PoE, eFuse and relay replacement.

2. Features and benefits

- Enhanced safe operating area (SOA) for superior linear mode operation
- Low R_{DSon} for low I²R conduction losses
- 2 mm x 2 mm space-saving DFN2020 package, 60% smaller than LFPAK33
- Very low I_{DSS} leakage

3. Applications

- High power PoE applications (60 W and higher)
- IEEE802.3at and proprietary PoE solutions
- Fault tolerant load switch Inrush management and eFuse applications
- Battery management applications
- Relay replacement
- WIFI hotspots
- 5G picocells
- CCTV

4. Quick reference data

Table 1. Qui	ck reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C	-	-	100	V
ID	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	-	-	18.4	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>	-	-	42	W
Tj	junction temperature		-55	-	175	°C
Static chara	acteristics	· · ·				
R _{DSon}	drain-source on-state	V _{GS} = 10 V; I _D = 5 A; T _j = 25 °C; <u>Fig. 11</u>	-	42	53.4	mΩ
	resistance	V _{GS} = 10 V; I _D = 5 A; T _j = 100 °C; Fig. 12	-	66	85	mΩ
Dynamic ch	naracteristics					
Q _{GD}	gate-drain charge	I _D = 5 A; V _{DS} = 50 V; V _{GS} = 10 V;	0.5	1.5	3.5	nC
Q _{G(tot)}	total gate charge	T _j = 25 °C; <u>Fig. 13; Fig. 14</u>	4.5	9	13.5	nC

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit		
Avalanche rug	Avalanche ruggedness								
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$ \begin{array}{l} {I_D = 10.6 \; \text{A}; \; V_{sup} \leq \; 100 \; \text{V}; \; \text{R}_{GS} = 50 \; \Omega; \\ {V_{GS} = 10 \; \text{V}; \; \text{T}_{j(init)} = 25 \; ^\circ\text{C}; \; \text{unclamped}; \\ {t_p = 20 \; \mu\text{s}; \; \underline{\text{Fig. 4}}} \end{array} } \end{array} $	[1]	-	-	13.8	mJ		
Source-drain d	Source-drain diode								
Q _r	recovered charge	$ I_{S} = 5 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ V_{DS} = 50 \text{ V}; \text{ T}_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 17} $		-	22.3	-	nC		

[1] Protected by 100% test

5. Pinning information

Table 2. F	Fable 2. Pinning information								
Pin	Symbol	Description	Simplified outline	Graphic symbol					
1	D	drain							
2	D	drain							
3	G	gate		D					
4	S	souce							
5	D	drain	3 8 4	G-UFA					
6	D	drain	Transparent top view	mbb076 S					
7	D	drain	DFN2020M-6 (SOT1220-2)						
8	S	souce							

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PSMN047-100NSE	DFN2020M-6	plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals; body 2 x 2 x 0.65 mm	SOT1220-2

7. Marking

Table 4. Marking codes	
Type number	Marking code
PSMN047-100NSE	ZT

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Tj = 25 °C unless otherwise stated.

Symbol	Parameter	Conditions	Min	Мах	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C	-	100	V
V _{DGR}	drain-gate voltage	25 °C ≤ T _j ≤ 175 °C; R _{GS} = 20 kΩ	-	100	V
V _{GS}	gate-source voltage		-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>	-	42	W

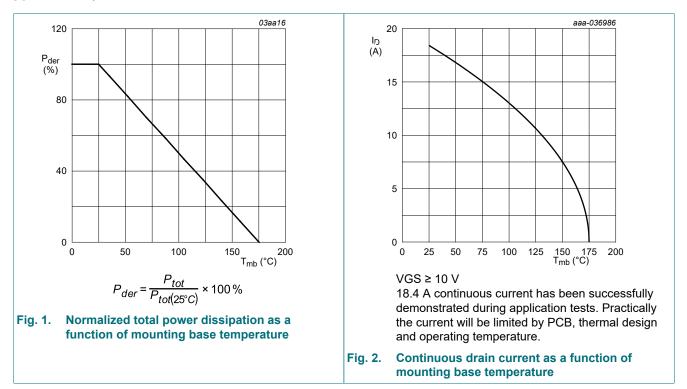
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PSMN047-100NSE

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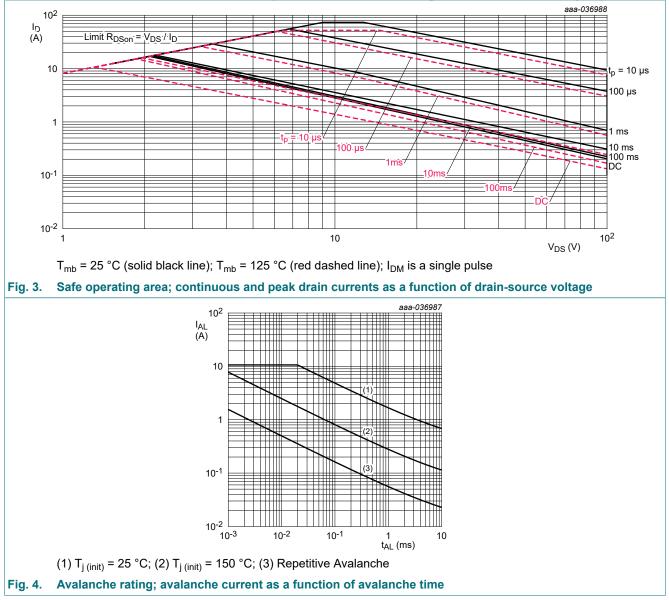
Symbol	Parameter	Conditions		Min	Max	Unit
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>		-	18.4	A
		V _{GS} = 10 V; T _{mb} = 100 °C; <u>Fig. 2</u>		-	13	A
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; Fig. 3		-	74	А
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
T _{sld(M)}	peak soldering temperature			-	260	°C
Source-drai	n diode					
I _S	source current	T _{mb} = 25 °C		-	18.4	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$		-	74	А
Avalanche r	uggedness	1		_		
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$ \begin{split} &I_{D} = 10.6 \text{ A}; \text{V}_{\text{sup}} \leq \ 100 \text{ V}; \text{R}_{\text{GS}} = 50 \Omega; \\ &\text{V}_{\text{GS}} = 10 \text{ V}; \text{T}_{\text{j(init)}} = 25 ^{\circ}\text{C}; \text{ unclamped}; \\ &t_{p} = 20 \mu\text{s}; \text{Fig. 4} \end{split} $	[1]	-	13.8	mJ
I _{AS}	non-repetitive avalanche current	$V_{sup} \le 100 \text{ V}; V_{GS} = 10 \text{ V}; T_{j(init)} = 25 \text{ °C}; R_{GS} = 50 \Omega; Fig. 4$	[1]	-	10.6	A

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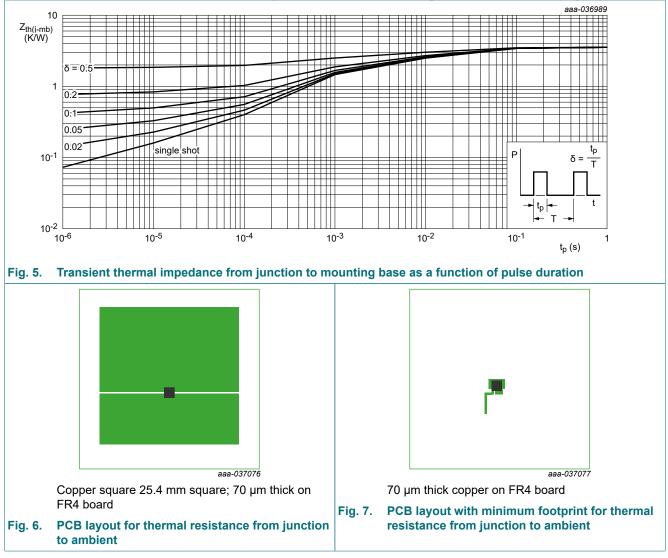


9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	3.2	3.6	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	Fig. 6	-	63	-	K/W
		<u>Fig. 7</u>	-	239	-	K/W

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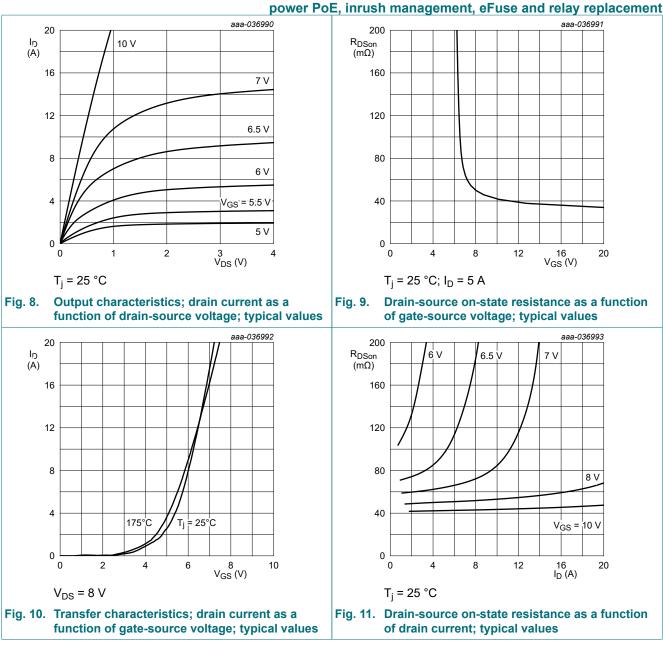


10. Characteristics

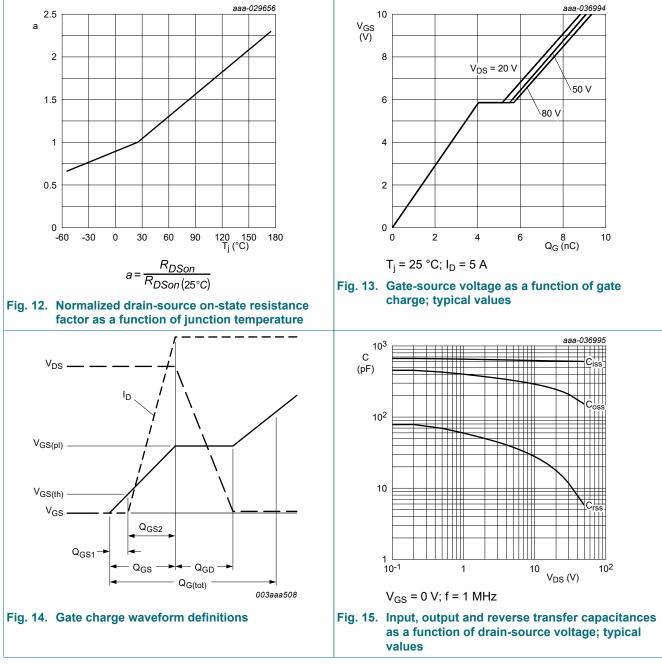
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static charac	teristics		I			
V _{(BR)DSS}	drain-source	$I_D = 250 \ \mu A; V_{GS} = 0 \ V; T_j = 25 \ ^{\circ}C$	100	-	-	V
	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C	90	-	-	V
V _{GS(th)}	gate-source threshold voltage	I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 25 °C	2	2.8	3.6	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C	-	1.9	-	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C	-	3.1	-	V
$\Delta V_{GS(th)} / \Delta T$	gate-source threshold voltage variation with temperature	25 °C ≤ T _j ≤ 150 °C	-	-5.2	-	mV/K
I _{DSS}	drain leakage current	V_{DS} = 100 V; V_{GS} = 0 V; T_j = 25 °C	-	0.01	1	μA
		V _{DS} = 100 V; V _{GS} = 0 V; T _j = 125 °C	-	1.3	100	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = -20 V; V _{DS} = 0 V; T _i = 25 °C	-	2	100	nA

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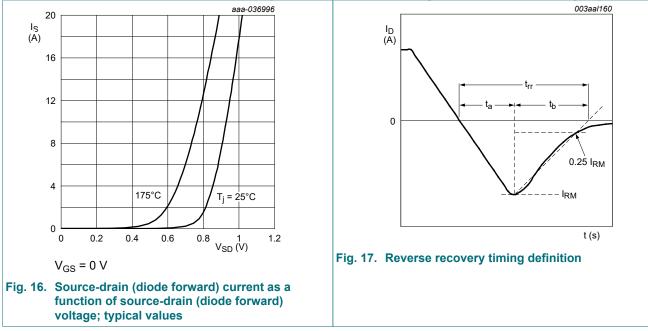
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{DSon}	drain-source on-state	V _{GS} = 10 V; I _D = 5 A; T _j = 25 °C; <u>Fig. 11</u>	-	42	53.4	mΩ
	resistance	V _{GS} = 10 V; I _D = 5 A; T _j = 100 °C; Fig. 12	-	66	85	mΩ
		V _{GS} = 10 V; I _D = 5 A; T _j = 175 °C; Fig. 12	-	93	121	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C	0.5	1	2	Ω
Dynamic ch	aracteristics	1				
Q _{G(tot)}	total gate charge	$I_{D} = 5 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V}; T_{j} = 25 \text{ °C}; Fig. 13; Fig. 14$	4.5	9	13.5	nC
		$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V};$ $T_j = 25 \text{ °C}$	-	8	-	nC
Q _{GS}	gate-source charge	$I_D = 5 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$ $T_j = 25 \text{ °C}; Fig. 13; Fig. 14$	2.4	4	5.6	nC
Q _{GS(th)}	pre-threshold gate- source charge		-	2	-	nC
Q _{GS(th-pl)}	post-threshold gate- source charge		-	2	-	nC
Q _{GD}	gate-drain charge		0.5	1.5	3.5	nC
V _{GS(pl)}	gate-source plateau voltage	I _D = 5 A; V _{DS} = 50 V; T _j = 25 °C; <u>Fig. 13;</u> Fig. 14	-	5.9	-	V
C _{iss}	input capacitance	Fig. 12 f = 1 MHz; T _j = 25 °C $I_D = 5 A; V_{DS} = 50 V; V_{GS} = 10 V;$ T _j = 25 °C; Fig. 13; Fig. 14 $I_D = 0 A; V_{DS} = 0 V; V_{GS} = 10 V;$ T _j = 25 °C $I_D = 5 A; V_{DS} = 50 V; V_{GS} = 10 V;$ T _j = 25 °C; Fig. 13; Fig. 14 $I_D = 5 A; V_{DS} = 50 V; T_j = 25 °C; Fig. 13;$ Fig. 14 $V_{DS} = 50 V; V_{GS} = 0 V; f = 1 MHz;$ T _j = 25 °C; Fig. 15 $V_{DS} = 50 V; R_L = 10 \Omega; V_{GS} = 10 V;$ R _{G(ext)} = 5 $\Omega; T_j = 25 °C$ $I_S = 5 A; V_{GS} = 0 V; T_j = 25 °C; Fig. 16$ $I_S = 5 A; dI_S/dt = -100 A/\mus; V_{GS} = 0 V;$	363	605	847	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 15</u>	91.2	152	243	pF
C _{rss}	reverse transfer capacitance		0.6	5.7	15	pF
t _{d(on)}	turn-on delay time		-	4.4	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 °C$	-	3.3	-	ns
t _{d(off)}	turn-off delay time	1	-	6.2	-	ns
t _f	fall time	1	-	6.1	-	ns
Source-drai	n diode		1			
V _{SD}	source-drain voltage	I _S = 5 A; V _{GS} = 0 V; T _j = 25 °C; <u>Fig. 16</u>	-	0.85	1	V
t _{rr}	reverse recovery time		-	28.5	-	ns
Qr	recovered charge	V _{DS} = 50 V; T _j = 25 °C; <u>Fig. 17</u>	-	22.3	-	nC





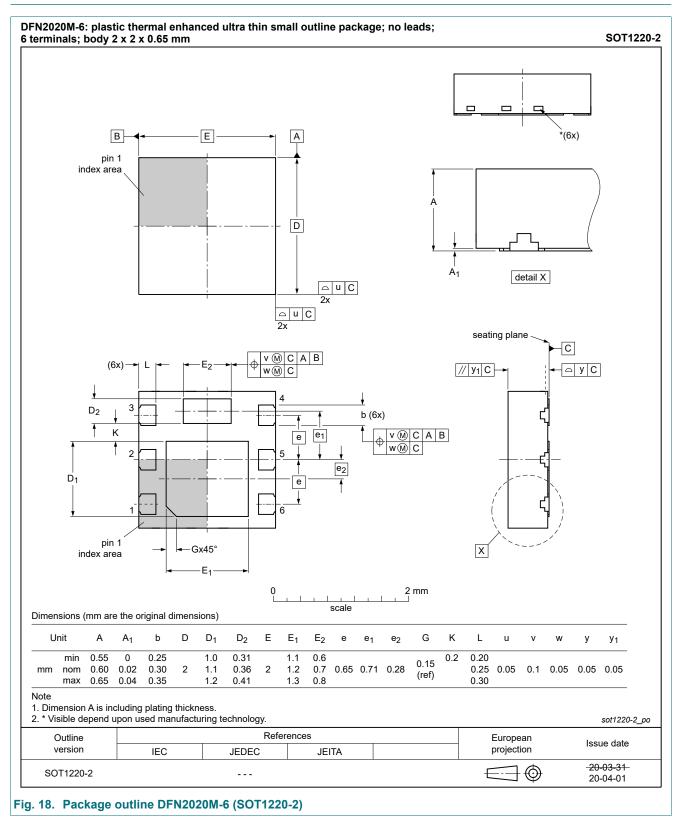


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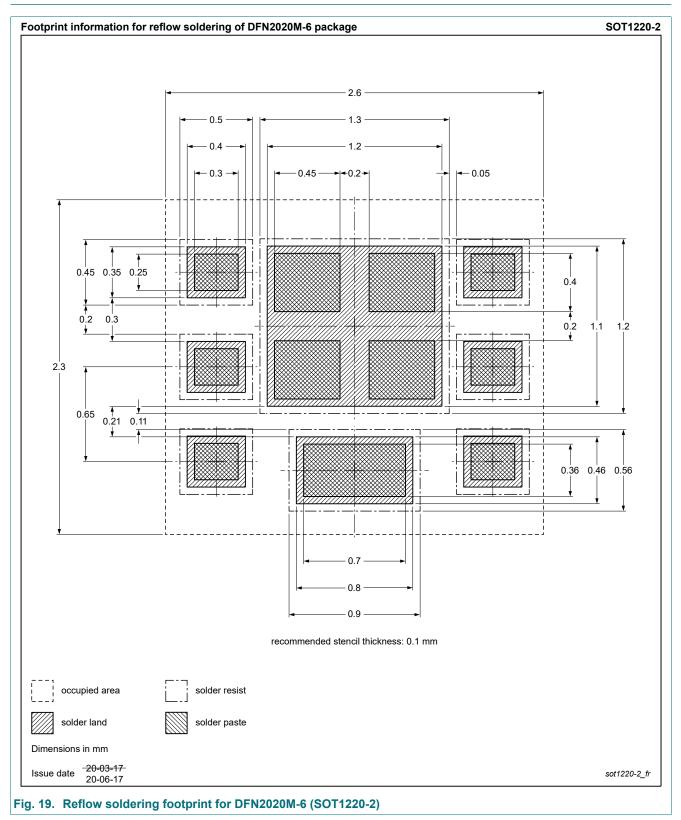
N-channel 100 V, 53 mOhm standard level ASFET with enhanced SOA in DFN2020. Designed for high power PoE, inrush management, eFuse and relay replacement

11. Package outline



N-channel 100 V, 53 mOhm standard level ASFET with enhanced SOA in DFN2020. Designed for high power PoE, inrush management, eFuse and relay replacement

12. Soldering



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13. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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[2] The term 'short data sheet' is explained in section "Definitions".

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